

Data requirements for semiconductor die —

Part 4-2: Specific requirements and recommendations — Handling and storage

ICS 31.080.01

National foreword

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Cross-references

The British Standards which implement international publications referred to in this document may be found in the BSI Standards Catalogue under the section entitled “International Standards Correspondence Index”, or by using the “Find” facility of the BSI Standards Electronic Catalogue.

Summary of pages

This document comprises a front cover, an inside front cover, the ES title page, pages 2 to 10, an inside back cover and a back cover.

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Amendments issued since publication

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